OYBEROPTICS

SE ULTRA SERIES

World-class Accuracy at Fastest Speed



*On standard parts only (excludes conveyor belts and other consumables); 1 year warranty on service

FASTEST, MOST ACCURATE 3-D SPI

- All-new, Ultrafast Sensor with Calibration-free Design
- 30% Faster with Unique 'All-in-one' Scan Sequence
- New, Intuitive Touch Screen Interface with World-class Usability
- Improved Repeatability with Dual Illumination Sensor Option
- Closed Loop Printer Feedback Ready
- CyberPrint OPTIMIZER™ Ready
- Mounter Feed Forward Ready

FASTER, MORE ACCURATE PERFORMANCE

An all-new, ultra-fast sensor combined with a unique 'all-in-one' scan sequence makes the SE500ultra 30% faster than its predecessor SPI systems.

Designed and built by CyberOptics, the ULTRA sensor is manufactured as an integrated unit with no moving parts – which means no machine-to-machine variation. Plus, there is no drift, no parts to wear and absolutely no recalibration needed.

For improved repeatability, you can choose from the MicroPad and Dual Illumination sensor options for accurately measuring pads as small as 100 microns (4 mils).



MicroPad Sensor

or Dual Illumination Sensor





140 x 140 micron pads

100 x 150 micron pads

NEW, AWARD-WINNING INTUITIVE SOFTWARE

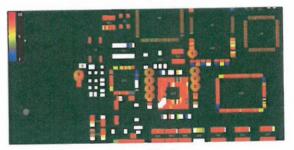
The brand-new V5 series software delivers world-class user experience with its intuitive interface, completely changing the way users interact with our system. Yet, at the same time, the software is extremely stable and simple to use enabling shortest learning curve.

With full multi-touch experience, SPI V5 series software offers a range of revolutionary features that enable smarter and faster inspection:

- Seamless integration of all applications Teach, Inspection, Defect Review and Real-time SPC
- Unlimited undo-redo and global search options in Teach
- Loads of smart, informative and relevant charts that provide yield summary, FPY information, hotspot display, top 10 pad failures, historical panel and more.
- Easy, hassle-free operation using multi-touch, multi-selection, pinch-zoom and pan-move options



Defect Review Interface



Hotspot Display



Real-time SPC

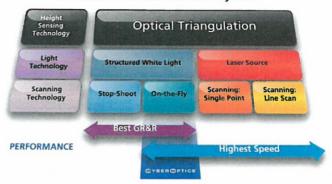
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HIGH SPEED, ON-THE-FLY INSPECTION

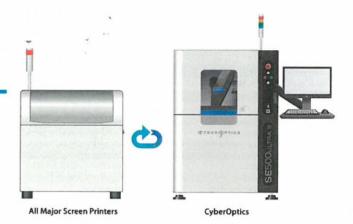
SE500ULTRA incorporates CyberOptics' patented 3-D sensing technology that uses white strobe light acquiring full FOVs with each strobe and minimizing vibration effects - delivering good accuracy and consistent repeatability. You can measure ANY PCB surface - including flexible circuits - as white light causes minimum diffusion. With its continuous image acquisition, you can be assured of fast, focused and reliable inspection.

3D Solder Paste Measurement System



FEEDBACK, FEED FORWARD READY

SE500ultra fully supports feedback and feed forward capability with leading Solder Paste Printer and SMT Mounter vendors respectively. With simple configuration settings, SE500ultra gives you the power to do more with SPI results - optimize printing process, establish stencil cleaning cycles and fine-tune printer setup. All this means reduced rework costs, increased production throughput and improved yields.



CYBERPRINT OPTIMIZER™ READY

CyberPrint OPTIMIZER™ automatically optimizes the print process by proactively analyzing accurate trend data – first-ever in the industry! Pre-defined templates help you get started quickly while customizable rules support perfect customization for specific product needs. CyberPrint OPTIMIZER™'s predictive process improvement gets you better yields and reduces downtime.



Failure analysis drives line optimization and auto tolerance changes

SMART PROCESS CONTROL

CyberOptics™ offers a full range of historical data analysis tools with drill-down capability and auto-reporting feature.

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SE500ULTRA

SYSTEM SPECIFICATIONS	
Panel Size Capacity (Max.)	510 x 510 mm (20.0 x 20.0 in.)
Panel Size Capacity (Min.)	50 x 50 mm (2.0 x 2.0 in.)
Dimensions (W x D x H)	100 x 127 x 139 cm
Weight	~855 kg (1885 lbs.)
Maximum Panel Weight	3.0 kg (6.6 lbs.)
Board Thickness	0.3 to 5.0 mm (0.01 to 0.2 in.)
Board Edge Clearance	Top: 2.5 mm (0.10 in.), Bottom: 3.0 mm (0.12 in.)
Component Clearance	Top (above belt): 20.1 mm (0.78 in.), Bottom: 25.4 mm (1.0 in.)
Conveyor Speed Range	150 - 450 mm/sec (5.9 – 17.7 in /sec)
Conveyor Adjustment	Automatic



508 x 503 mm (20.0 x 19.8 in.) Field-of-View 32 x 32 mm (1.26 x 1.26 in.) X and Y Pixel Size High Resolution: 15 µm (0.6 mils), High Speed: 30 µm (1.2 mils) 50 - 500 µm (2 - 20 mils) Paste Height Range 0.2 µm (0.008 mils) **Height Resolution** <2% of PCB diagonals or a max. of 6.35 mm (0.25 in.) total Maximum Board Warp 15 x 15 mm (0.6 x 0.6 in.) Maximum Pad Size in FOV Height, Area, Volume, Registration, Bridge Detection, Defect Review Measurement Types Machine Interface SMEMA, RS232 & Ethernet 100 - 130/220 - 240 V (±10%), 50/60 Hz, 10 - 15 amps **Power Requirements** Compressed Air Requirements 5.6 to 7.0 kgf/cm2 (80 to 100 psi @ 4 cfm)

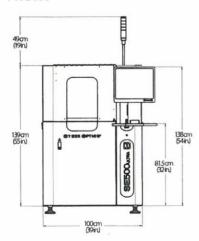
PERFORMANCE SPECIFICATIONS

Up to 210 cm²/sec (32.5 in²/sec) Inspection Speeds @ 30um 80 cm²/sec (12.3 in²/sec) Inspection Speed @ 15um Fiducial, Barcode and Skip Mark All-in-one scan 2 µm on a Certification Target Height Accuracy† <<10%, 6 a Gage R&R† † Under controlled conditions

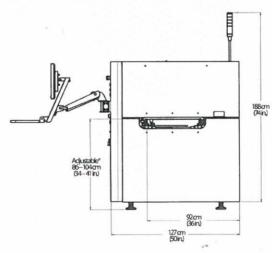
OPTIONS

SPC Software, Barcode Readers (1D/2D), Programming software: ePM-SPI/AOI & GC-PowerPlace, Offline Defect Review, Certification Target, Dual Illumination Kit

FRONT



SIDE





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www.cyberoptics.com